

Clean Version of Paragraph 1 of Page 2 of the Specification:

BI The bond pads 210 through 217 are electrically coupled to a series of driver/ESD circuit cells 220 through 227. The term "ESD" refers to "electrostatic discharge". The driver/ESD cells 220 through 227 provide drive strength for output signals, receive input signals, and also provide ESD protection. The driver/ESD cells 220 through 227 are coupled to the bond pads 210 through 217 via metal connections. Two of the metal connections are labeled 240 and 247. Metal connection 240 connects bond pad 210 to driver/ESD cell 220, and metal connection 247 connects bond pad 217 to driver/ESD cell 227. The driver/ESD cells 220 through 227 are connected to a series of pre-driver cells 230 through 237 via a series of signal lines. Two of these lines are labeled 250 and 257. These cells serve to couple the driver/ESD cells with the circuitry located at the die core.